## **Amendments to the Claims:**

The listing of claims will replace all prior versions, and listings of claims in the application:

## **Listing of Claims:**

Claims 1 - 10 (cancelled)

Claim 11 (currently amended)

A kind of non-volatile memory structure, including:

a base;

a gate dielectric layer on the base, the gate dielectric layer <u>with an increased</u> <u>electron trapping density</u> has at least one kind of hetero element, other than Nitrogen, to increase the electron trapping density;

a gate electrode layer on the top of the said gate dielectric layer; and a source/drain electrodes at the base on both sides of the said gate dielectric layer.

Claim 12 (previously presented) The non-volatile memory structure as claimed in claim 11, where the gate dielectric layer in turns from bottom to the top including a first oxide layer, a nitride layer and a second oxide layer.

Claim 13 (previously presented) The non-volatile memory structure as claimed in claim 11, where the hetero elements used are any one within Germanium (Ge), Silicon (Si), Oxygen (O<sub>2</sub>), Oxygen (O) separately or multiple mixture therefrom.

Claim 14 (previously presented) The non-volatile memory structure as claimed in claim 11, where the hetero elements used are compounds of Germanium (Ge), Silicon (Si), Oxygen (O).

Claim 15 (new) The non-volatile memory structure as claimed in claim 11, where the hetero elements used are compounds of Germanium (Ge).

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Claim 16 (new) The non-volatile memory structure as claimed in claim 11, where the hetero elements used are compounds of Oxygen (O).